at least one circuit pattern is provided in at least one of the circuit layers in the cable section of the circuit strata, wherein

at least one of the top and bottom of the circuit strata of the cable section is covered only by an adhesive, and wherein

the adhesive comprises acrylic.

REMARKS

Claims 1-22 were pending in the present application. Claims 3, 4, 8, 9, 17, and 18 have been amended. Claims 1, 2, 5, 6, 7, 10-16 and 19-22 have been cancelled. No claims have been added. Therefore Claims 3, 4, 8, 9, 17, and 18 are pending in the present application.

Applicants thank the Examiner for indicating that claims 3, 4, 8, 9, 17, and 18 contain allowable subject matter.

Conclusion

In light of the above amendments, Applicants believe that the present application is in condition for allowance. Entry of the present claim revisions and favorable reconsideration are requested.

If Applicants have not accounted for any fees required by this Amendment, the Commissioner is hereby authorized to charge to our Deposit Account No. 19-0741. If applicants have not accounted for a required extension of time under 37 C.F.R. § 1.136, that extension is requested and the corresponding fee should be charged to our Deposit Account.

Examiner Norris is invited to contact the undersigned by telephone if it is felt that a telephone interview would advance the prosecution of the present application.

Ju Martin J. Cosenza Rymo 35,264
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Respectfully submitted,

Date _____Feb. 19, 2003

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VERSION WITH MARKINGS TO SHOW CHANGES MADE (CLAIMS)

3. (Twice Amended) A flexible printed circuit board as described in Claim 1, comprising a component mount section, which an electronic component is mounted on, and a cable section, which connects to the component mount section;

circuit patterns being provided in the cable section, and covered by a soft laminated adhesive, the adhesive being the outermost layers of the cable section, the laminating adhesive comprising a polyimide adhesive.

4. (Amended) A flexible printed circuit board as described in Claim 1, comprising a component mount section, which an electronic component is mounted on, and a cable section, which connects to the component mount section;

circuit patterns being provided in the cable section, and covered by a soft laminated adhesive, the adhesive being the outermost layers of the cable section, the laminating adhesive comprising an acrylic adhesive.

8. (Amended) The board of claim 6, wherein A flexible printed circuit board having a cable section connected to at least one component mount section comprising:

a circuit strata comprising at least one circuit layer, the circuit strata comprising all the circuit layers of the circuit board, wherein the circuit strata is located in both the cable section and at least one component mount section, the strata of the cable section connecting to the strata of at least one component mount section; wherein;

at least one circuit pattern is provided in at least one of the circuit layers in the cable section of the circuit strata, wherein

at least one of the top and bottom of the circuit strata is covered by a soft laminated adhesive, wherein

the printed circuit board is adapted on at least one mount section to permit an electronic component to be mounted on the component mount section, and wherein the soft laminated adhesive comprises polyimide.

9. (Amended) The board of claim 6, A flexible printed circuit board having a cable section connected to at least one component mount section comprising:

a circuit strata comprising at least one circuit layer, the circuit strata comprising all the circuit layers of the circuit board, wherein the circuit strata is located in both the cable section and at least one component section, the strata of the cable section connecting to the strata of at least one component mount section; wherein

at least one circuit pattern is provided on at least one of the circuit layers in the cable section of the circuit strata, wherein

at least one of the top and bottom of the circuit strata is covered by a soft laminated adhesive, wherein,

the printed circuit board is adapted at least one mount section to permit an electronic component to be mounted on the component mount section, and

wherein the soft laminated adhesive comprises acrylic.

17 (Amended) The board of claim 16, wherein the soft laminated A flexible printed circuit board having a cable section connected to at least one component mount section comprising:

a circuit strata comprising at least one circuit layer, the circuit strata comprising all the circuit layers of the circuit board, wherein the circuit strata is located in both the cable section and at least one component section, the strata of the cable section connecting to the strata of at least one component mount section; wherein

at least one circuit pattern is provided in at least one of the circuit layers in the cable section of the circuit strata, wherein

at least one of the top and bottom of the circuit strata of the cable section is covered only by an adhesive, and wherein

the adhesive comprises polyimide.

18. (Amended) The board of claim 16, wherein the soft laminated A flexible printed circuit board having a cable section connected to at least one component mount section comprising:

a circuit strata comprising at least one circuit layer, the circuit strata comprising all the circuit layers of the circuit board, wherein the circuit strata is located in both the cable section and at least one component section, the strata of the cable section connecting to the strata of at least one component mount section; wherein

at least one circuit pattern is provided in at least one of the circuit layers in the cable section of the circuit strata, wherein

at least one of the top and bottom of the circuit strata of the cable section is covered only by an adhesive, and wherein

the adhesive comprises acrylic.